What is claimed:

- A radiation curable resin composition, containing essentially no
 volatile organic components, comprising:
 - at least one vinyl dioxolane end-capped oligomer, and at least one photoinitiator to initiate radiation cure of the oligomer.
- The radiation curable resin composition of claim 1, wherein the
 radiation cure of the oligomer comprises UV, visible light or electron beam cure.
 - 3. The radiation curable resin composition of claim 1, wherein the radiation cure of the oligomer comprises UV-cure.
 - 4. The radiation curable resin composition of claim 1, wherein the vinyl dioxolane end-capped oligomer comprises a polyester, acrylate, polyurethane, or copolymers or blends thereof.
- 5. The radiation curable resin composition of claim 4, wherein the vinyl dioxolane end-capped oligomer comprises a polyester.
 - 6. The radiation curable resin composition of claim 5, wherein the polyester is derived from at least one ester of a polycarboxylic acid.
 - 7. The radiation curable resin composition of claim 6, wherein the ester is dimethyl adipate or dimethyl 1,4-cyclohexanedicarboxylate.
- 8. The radiation curable resin composition of claim 4, wherein the vinyl dioxolane end-capped oligomer comprises a polyurethane.

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9. The radiation curable resin composition of claim 8, wherein the polyurethane is derived from at least one isocyanate or polyisocyanate having the formula

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R₆(NCO)_p

wherein R_6 is an aliphatic or cycloaliphatic alkyl group having from 1 to about 10 carbon atoms or an aromatic group and p is at least 1, or at least one isocyanate-endcapped aliphatic urethane prepolymer having the formula

O O II II OCNR₉HNC - O - R₈ - OCNHR₇NCO

wherein R₇, R₈ and R₉ are independently an aliphatic or cycloaliphatic alkyl group having from 1 to about 10 carbons.

- 10. The coating composition of claim 8, wherein in the polyurethane is derived from at least one uretdione, isophorone diisocyanate, hexamethylene diisocyanate, 4,4-bis(cyclohexyl)methane diisocyanate, bis(4-isocyanatocyclohexyl)methane, 1-methylcyclohexane-2,4-diisocyanate, 4,4',4"-tricyclohexylmethane triisocyanate, toluene diisocyanate (TDI), methylene-bis-diphenylisocyanate (MDI), and nathalene diisocyanate.
 - 11. The radiation curable resin composition of claim 8, wherein the polyurethane comprises the reaction product of at least one aromatic isocyanate or polyisocyanate.

- 12. The radiation curable resin composition of claim 11, wherein the polyurethane is derived from tetramethyl xylene diisocyanate (TMXDI).
- 13. The radiation curable resin composition of claim 4, wherein the vinyldioxolane end-capped oligomer comprises an polyurethane acrylate.

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14. The radiation curable resin composition of claim 13, wherein the polyurethane activate comprises CN985-B88, CN963-B80, CN964-B85, CN-965-A80 and CN966-J75.

The radiation curable resin composition of claim 13, wherein the polyurethane acrylate comprises the reaction product of an acrylate and at least one of a branched polyfunctional isocyanate, aliphatic isocyanate-terminated urethane prepolymer, or aliphatic isocyanate-terminated polyester.

10 14 16. The radiation curable resin composition of claim 18, wherein the polyurethane acrylate comprises the reaction product of an acrylate and at least one aliphatic isocyanate-terminated urethane prepolymer.

15 17. The radiation curable resin composition of claim 16, wherein the aliphatic isocyanate-terminated urethane prepolymer has a molecular weight ranging from about 500 to 1000.

The radiation curable resin composition of claim 17, wherein the aliphatic isocyanate-terminated urethane prepolymer has a molecular weight ranging from about 500 to 600.

19. The radiation curable resin composition of claim 13, wherein the polyurethane acrylate comprises the reaction product of an acrylate and at least one HMDI-terminated polyethyleneadipate aliphatic urethane prepolymer.

The radiation curable resin composition of claim 1, wherein the vinyl dioxolane end-caps comprise substituted or unsubstituted vinyl hydroxy alkyl dioxolanes and vinyl carboxy alkyl dioxolanes, having from 2 to about 10 carbons.

The radiation curable resin composition of claim 20, wherein the vinyl-dioxolane end-caps are derived from 2-vinyl-4-hydroxybutyl-1,3-dioxolane (HBVD) or 2-vinyl-4-hydroxymethyl-1,3-dioxolane (HMVD).

	21	
	2 2.	The radiation curable resin composition of claim 1, wherein the
	photo	initiator comprises at least one alpha hydroxy ketone.
	12	2/
5	23.	The radiation curable resin composition of claim 22, wherein the
	alpha	hydroxy ketone comprises a polymeric hydroxy ketone.
	02	
	134.	The radiation curable resin composition of claim 1, wherein the
	photo	initiator is added in amounts of from about 0.5 to about 10 weight
10	perce	nt.
	24	
	28.	The radiation curable resin composition of claim 1, wherein the
	photo	initiator is added in amounts of from about 2 to about 6 weight
	perce	nt.
15	25	
	26.	The radiation curable resin composition of claim 1, wherein the
	photo	initiator is added in amounts of from about 4 to about 5 weight
	perce	nt.
	26	
20	24.	The radiation curable resin composition of claim 1, wherein the
	coatir	ng composition is sprayable.
	17	26
	28.	The radiation curable resin composition of claim 27 further
	comp	rising a reactive diluent.
25	28	27
	28.	The radiation curable resin composition of claim 28, wherein the
	reacti	ve diluent comprises at least one unsubstituted or monosubstituted
	vinyl o	dioxolane monomer.
	29	28
30	30.	The radiation curable resin composition of claim 29, wherein the vinyl
	dioxol	ane monomer comprises a polyester vinyl dioxolane (PEVD).
	30	27
	31.	The radiation curable resin composition of claim 28, wherein the
	reactiv	ve diluent is added in amounts of up to about 50 weight percent.

	31	3 0
	32.	The radiation curable resin composition of claim 31, wherein the
	react	ive diluent is added in amounts of up to about 25 weight percent.
	37,	31
	32.	The radiation curable resin composition of claim 32, wherein the
5	react	ive diluent is added in amounts of up to about 10 weight percent.
	33	27
	34.	The radiation curable resin composition of claim 28, wherein the
	react	ive diluent has a viscosity from about 10 to about 200 mPa•s at about
	23° C	.
10	24	·
	35.	The radiation curable resin composition of claim 1 further comprising
	a pig	ment.
	35	34
	36.	The radiation curable resin composition of claim 35, wherein the
15	pigme	ent is selected from titanium dioxide and carbon black.
	36	34
	37.	The radiation curable resin composition of claim 35, wherein the
	pigme	ent is added in amounts of about 0.1 to 30 weight percent.
	311	36
20	38.	The radiation curable resin composition of claim 31, wherein the
	- 1	ent is added in amounts of about 1 to about 25 weight percent.
	38	34.
	384	The radiation curable resin composition of claim 35, wherein the
0.5		initiator comprises at least one of polymeric hydroxy ketone,
25		thylbenzophenone, methylbenzophenone, benzyl dimethyl ketal,
		phenone.
	39	
	40.	The radiation curable resin composition of claim 1 wherein the one
30		dioxolane end-capped radiation curable oligomer is derinved from 2-
30		4-hydroxybutyl-1,3-dioxolane (HBVD), tetramethyl xylene diisocyanate
	(TIMIVI	OI) and an alpha hydroxy ketone photoinitiator.
	40	The radiation appeals regin company (1)
	7 1.	The radiation curable resin composition of claim 1 further comprising

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a co-initiator.

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	92.	The radiation curable resin composition of claim 41, wherein the co-
	initia	tor is a reactive amine.
	<i>98</i> .	The radiation curable resin composition of claim 41, wherein the co-
5	initia	tor is selected from Sartomer CN381, Sartomer CN384 and Sartomer
	CN38	36.
	42	40
	94.	The radiation curable resin composition of claim 14, wherein the co-
	initia	tor is added in amounts of from about 0.1 to about 5 weight percent.
10	43	40
	45.	The radiation curable resin composition of claim AI, wherein the co-
	initia	tor is added in amounts of from about 3 to about 5 weight percent.
	44	
	48.	The radiation curable resin composition of claim 1 further comprising
15	a wet	ting agent.
	45	44
	47.	The radiation curable resin composition of claim 46, wherein the
	,	ng agent is added in amounts of from about 0.1 to 0.5 weight percent.
00	46	
20	48.	The radiation curable resin composition of claim 1 further comprising
		pling agent.
	47	The mediation country and the second state of
	goveni	The radiation curable resin composition of claim 48, wherein the
25		ing agent is a silane coupling agent.
20	48 50.	The radiation curable resin composition of claim 48, wherein the
		ing agent is added in amounts of from about 0.5 to about 1.5 weight
	perce	_
	9	·
30	7 i 21.	The radiation curable resin composition of claim 1 further comprising
	a thix	otropic agent.
	/4	,14
	50 52.	The radiation curable resin composition of claim 51 wherein the
	thixot	ropic agent is fumed silica.

58. The radiation curable resin composition of claim 51, wherein the thixotropic agent is added in amounts of from about 0.1 to 10 weight percent.

54. A radiation curable resin composition, containing essentially no volatile organic components, comprising the reaction product of:

- (a) at least one polyester prepolymer which comprises the reaction product of
- (1) at least one substituted vinyl dioxolane monomer

 10 having the formula

wherein R_1 and R_1 ' are independently hydrogen or an alkyl group having from 1 to 10 carbon atoms, n is a number from 0 to about 10, and R_2 , R_3 , R_4 , and R_5 are independently hydrogen or an alkyl group having from 1 to about 10 carbon atoms; and

- (2) at least one
 - (i) ester of a polycarboxylic acid; or
 - (ii) hydroxy-functional acrylate; or
 - (iii) at least one isocyanate or polyisocyanate;

or

(iv) at least one isocyanate-endcapped aliphatic or aromatic urethane prepolymer, and

(b) at least one photoinitiator to initiate UV of visible light cure of the composition.

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53. A radiation curable resin composition of claim 54 wherein the at least one isocyanate or polyisocyanate has the formula

R₆(NCO)_P

wherein R₆ is an aliphatic or cycloaliphatic alkyl group havingfrom 1
to about 10 carbon atoms or an aromatic group and p is at least 1, and
wherein the least one isocyanate-endcapped aliphatic urethane
prepolymer has the formula

10

wherein R_7 , R_8 and R_9 are independently an aliphatic or cycloaliphatic alkyl group having from 1 to about 10 carbons/.

The radiation curable resin composition of claim 54, wherein the vinyl dioxolane monomer comprise substituted or unsubstituted vinyl hydroxy alkyl dioxolanes and vinyl carboxy alkyl dioxolanes, having from 2 to about 10 carbons.

20 57. The radiation curable resin composition of claim 56, wherein the vinyl dioxolane monomer is 2-vinyl-4-hydroxybutyl-1,3-dioxolane (HBVD) or 2-vinyl-4-hydroxymethyl-1,3-dioxolane (HMVD).

58. A method of providing a radiation curable polymer coating, the method comprising applying a radiation curable resin composition containing essentially no volatile organic components and enabling radiation cure of the resin composition, wherein the radiation curable resin comprises:

at least one one vinyl dioxolane end-capped oligomer, and at least one photoinitiator to initiate radiation cure of the composition.

The radiation curable resin composition of claim 22, wherein the photoinitiator comprises a mixture of an oligomeric alpha hydroxy ketone and 2-hydroxy-2-methyl-1-phenyl 1-propanone.

	58	2/
	<i>8</i> 6.	The radiation curable resin composition of claim 22, wherein the
	photo	oinitiator comprises 70 wt% of oligo(2-hydroxy-2-methyl-1-[4-(1-
	meth	ylvinyl)phenyl]propanone]) and 30 wt% of 2-hydroxy-2-methyl-1-phenyl
5	1-pro	panone.
	59 62	\mathcal{A}
	61.	The radiation curable resin composition of claim 22, wherein the
	photo	initiator comprises a blend of 2,4,6-
	trime	thylbenzoyldiphenylphosphine oxide, alpha-hydroxyketone and
10	benzo	phenone derivative.
	6 0	
	,62°.	The radiation curable resin composition of claim 1, wherein the
	photo	initiator comprises 2 hydoxy-2-ethyl-phenyl-1-propane.
	61	
15	<i>58</i> .	The radiation curable resin composition of claim 1, wherein the
	photo	initiator comprises bis(2,4,6-trimethylbenzoyl)-phenylphosphineoxide.
	42	
•	<i>54</i> .	The radiation curable resin composition of claim 1, wherein the
	_	initiator comprises 1-hydroxy cyclohexyl phenyl ketone.
20	43	
	68.	The radiation curable resin composition of claim 1, wherein the
		initiator comprises bis η ⁵ -2,4-cyclopentadien-1-yl)bis(2,6-difluoro-3-
		yrrol-1-yl)phenyl)titanium.
0.5	14	
25	68.	The radiation curable resin composition of claim 1, wherein the
		initiator comprises at least one of an alpha hydroxy ketone, a
		eric hydroxy ketone, trimethylbenzophene, methylbenzophenone, 2
		xy-2-ethyl-phenyl-1-propane, phosphine oxide, bis(2,4,6-
20		hylbenzoyl)-phenylphosphineoxide, 1-hydroxy cyclohexyl ketone,
30		l dimethyl ketal, trimethylbenzophenone, benzophenone, and bis η ⁵ -
	_	rclopentadien-1-yl) bis(2,6-difluoro-3-(1H-pyrrol-1-yl) phenyl) titanium.
	65	The radiation curable resin composition of claim 28, wherein the
	7 81.	- · · · · · · · · · · · · · · · · · · ·
25		ve diluent comprises at least one of diethylene glycol diacrylate (DGD),
35	tetrahydrofurfuryl acrylate, 2-phenoxyethyl acrylate, isooctyl acrylate,	

propoxylated neopentyl glycol diacrylate, triethyleneglycol diacrylate, hexanediol diacrylate, lauryl acrylate or trimethylopropane triacrylate (TMPTA).

5 68. The radiation curable resin composition of claim 1 further comprising at least one thermal cure catalyst to initiate thermal cure of the oligomer.

The radiation curable resin composition of claim 68, wherein the thermal cure catalyst is at least one of a peroxide or cobalt composition.

The radiation curable resin composition of claim 69, wherein the thermal cure catalyst is a peroxide combined with at least one transition metal soap.

The radiation curable resin composition of claim 69, wherein the peroxide is a high temperature peroxide comprising at least one of a tertiary butyl perbenzoate, 2,5-dimethyl-2,5-di(t-butylperoxy)hexane, dicumylperoxide, benzoyl peroxide and MEK peroxide.

20 **12.** The radiation curable resin composition of claim 1 further comprising at least one filler.

73. The radiation curable resin composition of claim 72, wherein the filler is an organic filler, inorganic filler or blends thereof, comprising at least one of Ni coated carbon powder, iron powder, titanium dioxide, carbon black and thiokol blue.

(40.8)